

# **Data Sheet**

# RBA250N04AHPF-4UA01

40V - 250A - N-channel Power MOS FET

R07DS1362EJ0300 Rev.3.00 Jul. 08, 2020

Application: Automotive

### **Description**

The RBA250N04AHPF-4UA01 is N-channel MOS Field Effect Transistor designed for high current switching applications.

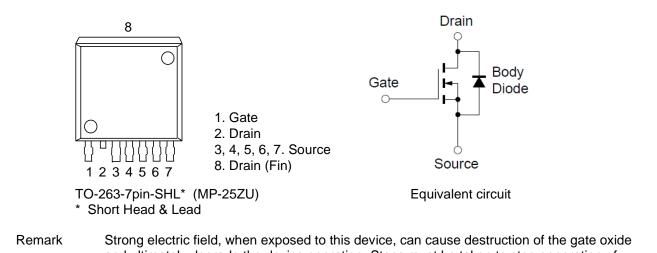
#### **Features**

- Super low on-state resistance  $R_{DS(on)} = 0.85 \text{ m}\Omega$  MAX. ( $V_{GS} = 10 \text{ V}$ ,  $I_D = 125 \text{A}$ )
- Low input capacitance
   Ciss = 12900pF TYP. (V<sub>DS</sub> = 25 V)
- Designed for automotive application and AEC-Q101 qualified
- Pb-free (This product does not contain Pb in the external electrode)

## **Ordering Information**

Part No.	Quantity	Shipping container		
RBA250N04AHPF-4UA01#GB0	800pcs/reel	Taping		

#### **Outline**



strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

# **Absolute Maximum Ratings**

(T<sub>A</sub>=25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	40	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±20	V
Drain Current (DC) (T <sub>C</sub> = 25 °C)	I <sub>D(DC)</sub>	±250	Α
Drain Current (pulse) Note1	I <sub>D(pulse)</sub>	±1000	Α
Total Power Dissipation (T <sub>C</sub> = 25 °C)	P <sub>T1</sub>	348	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	P <sub>T2</sub>	1.8	W
Channel Temperature	T <sub>ch</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to 175	°C
Repetitive Avalanche Current Note2	I <sub>AR</sub>	74	Α
Repetitive Avalanche Energy Note3	Ear	547	mJ

Note 1.  $P_W \le 10 \mu s$ , Duty Cycle  $\le 1\%$ 

### **Thermal Resistance**

Channel to Case Thermal Resistance	R <sub>th(ch-C)</sub>	0.43	°C/W
Channel to Ambient Thermal Resistance	R <sub>th(ch-A)</sub>	83.3	°C/W

## **Electrical Characteristics**

 $(T_A=25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V
Gate Leakage Current	I <sub>GSS</sub>			±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA
Drain to Source On-state Resistance	R <sub>DS(on)</sub> Note4		0.72	0.85	mΩ	Vgs = 10 V, ID = 125 A
Input Capacitance	C <sub>iss</sub> Note5		12900	19350	pF	Vps = 25 V
Output Capacitance	Coss Note5		1480	2220	pF	V <sub>G</sub> s = 0 V
Reverse Transfer Capacitance	C <sub>rss</sub> Note5		680	1220	pF	f = 1 MHz
Turn-on Delay Time	t <sub>d(on)</sub> Note5		45	90	ns	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 125 A
Rise Time	t <sub>r</sub> Note5		20	50	ns	Vgs = 10 V
Turn-off Delay Time	t <sub>d(off)</sub> Note5		148	296	ns	$R_G = 0 \Omega$
Fall Time	t <sub>f</sub> Note5		26	65	ns	
Total Gate Charge	Q <sub>G</sub> Note5		245	368	nC	V <sub>DD</sub> = 32 V
Gate to Source Charge	Q <sub>GS</sub> Note5		56		nC	Vgs = 10 V
Gate to Drain Charge	Q <sub>GD</sub> Note5		77		nC	I <sub>D</sub> = 250A
Body Diode Forward Voltage	V <sub>F(S-D)</sub> Note4		0.9	1.5	V	I <sub>F</sub> = 250 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub> Note5		94		ns	IF = 250 A, VGS = 0 V
Reverse Recovery Charge	Q <sub>rr</sub> Note5		112		nC	di/dt = 100 A/μs

Note 4. Pulse test

Note 5. Refer value



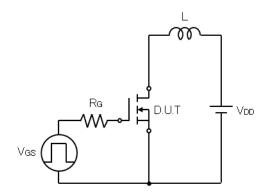
<sup>2.</sup>  $V_{GS} = 20 \rightarrow 0V$ ,  $R_G = 25 \Omega$ 

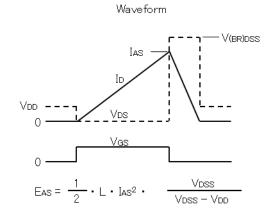
<sup>3.</sup> L = 100 $\mu H$  , V<sub>DD</sub> = 20V , V<sub>GS</sub> = 20  $\rightarrow$  0V, R<sub>G</sub> = 25  $\Omega$ 

# **Test Circuit**

Avalanche

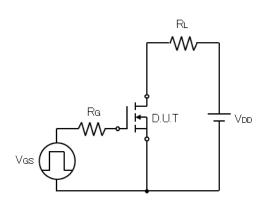
Test Circuit

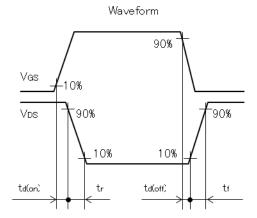




Switching Time

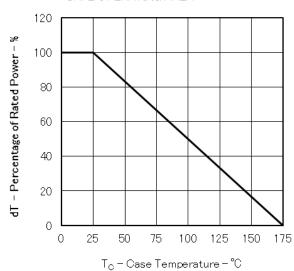
Test Circuit



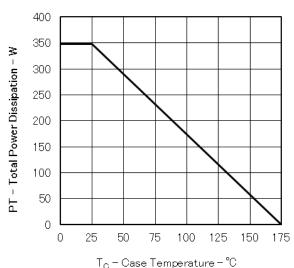


# **Typical Characteristics (TA = 25°C)**

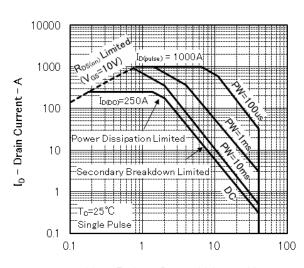
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



#### TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

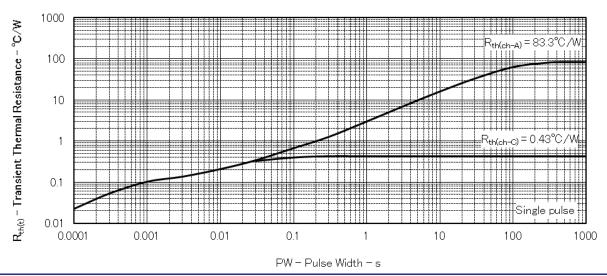


#### FORWARD BIAS SAFE OPERATING AREA

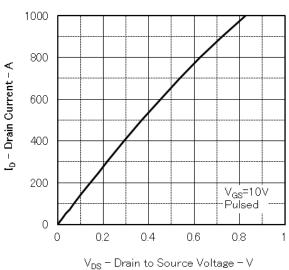


#### $V_{DS}$ - Drain to Source Voltage - V

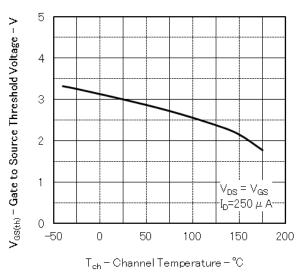
### TRANSIENT THREMAL RESISTANCE vs. PULSE WIDTH



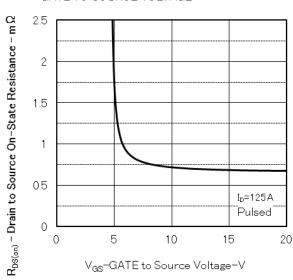




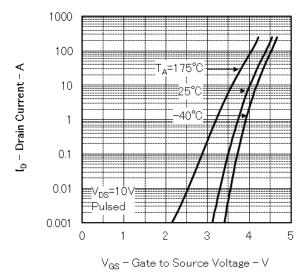
# GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



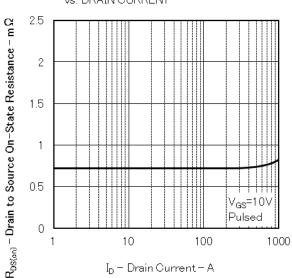
# DRAIN TO SOURCE ON-STATERESISTANCE vs. GATE TO SOURCE VOLTAGE



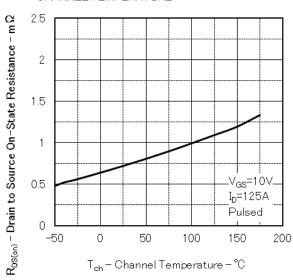
#### FORWARD TRANSFER CHARACTERISTICS



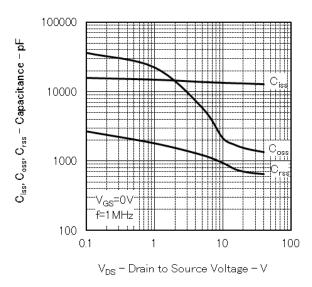
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



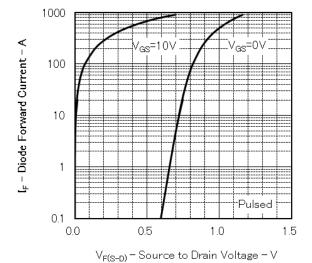
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



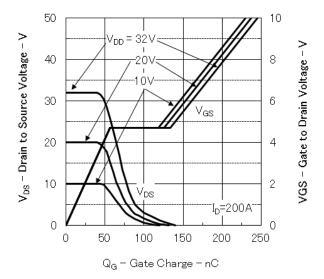
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



#### SOURCE TO DRAIN DIODE FORWARD VOLTAGE



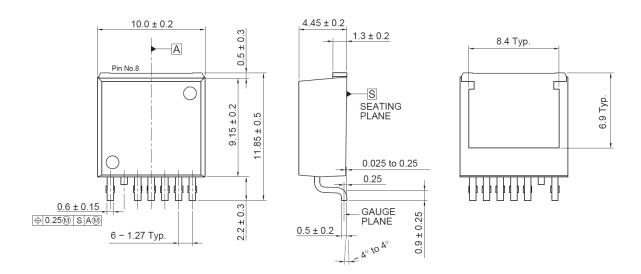
#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS



# **Package Dimensions**

JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]	Package Name
_	PRSS0008DC-A	_	1.39	MP-25ZU

Unit: mm





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